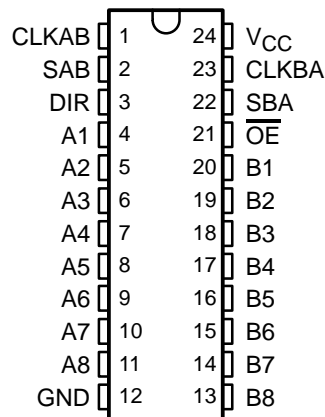


SN54HCT646, SN74HCT646 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

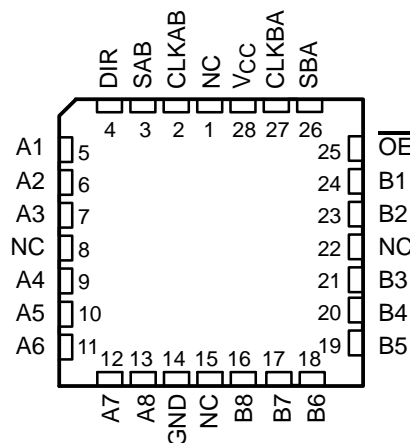
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- Operating Voltage Range of 4.5 V to 5.5 V
- Low Power Consumption, 80- μ A Max I_{CC}
- Typical $t_{pd} = 12$ ns
- ± 6 -mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- Inputs Are TTL-Voltage Compatible
- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- True Data Paths
- High-Current 3-State Outputs Can Drive Up To 15 LSTTL Loads

SN54HCT646 . . . JT OR W PACKAGE
SN74HCT646 . . . DW OR NT PACKAGE
(TOP VIEW)



SN54HCT646 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

The 'HCT646 devices consist of bus-transceiver circuits with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'HCT646 devices.

Output-enable (\overline{OE}) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port can be stored in either or both registers.

ORDERING INFORMATION

T _A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	PDIP – NT	Tube	SN74HCT646NT	HCT646
	SOIC – DW	Tube	SN74HCT646DW	
		Tape and reel	SN74HCT646DWR	
–55°C to 125°C	CDIP – JT	Tube	SNJ54HCT646JT	SNJ54HCT646JT
	CFP – W	Tube	SNJ54HCT646W	SNJ54HCT646W
	LCCC – FK	Tube	SNJ54HCT646FK	SNJ54HCT646FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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**TEXAS
INSTRUMENTS**

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SN54HCT646, SN74HCT646

OCTAL BUS TRANSCEIVERS AND REGISTERS

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description/ordering information (continued)

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. DIR determines which bus receives data when \overline{OE} is active (low). In the isolation mode (\overline{OE} high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function still is enabled and can be used to store data. Only one of the two buses, A or B, can be driven at a time.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

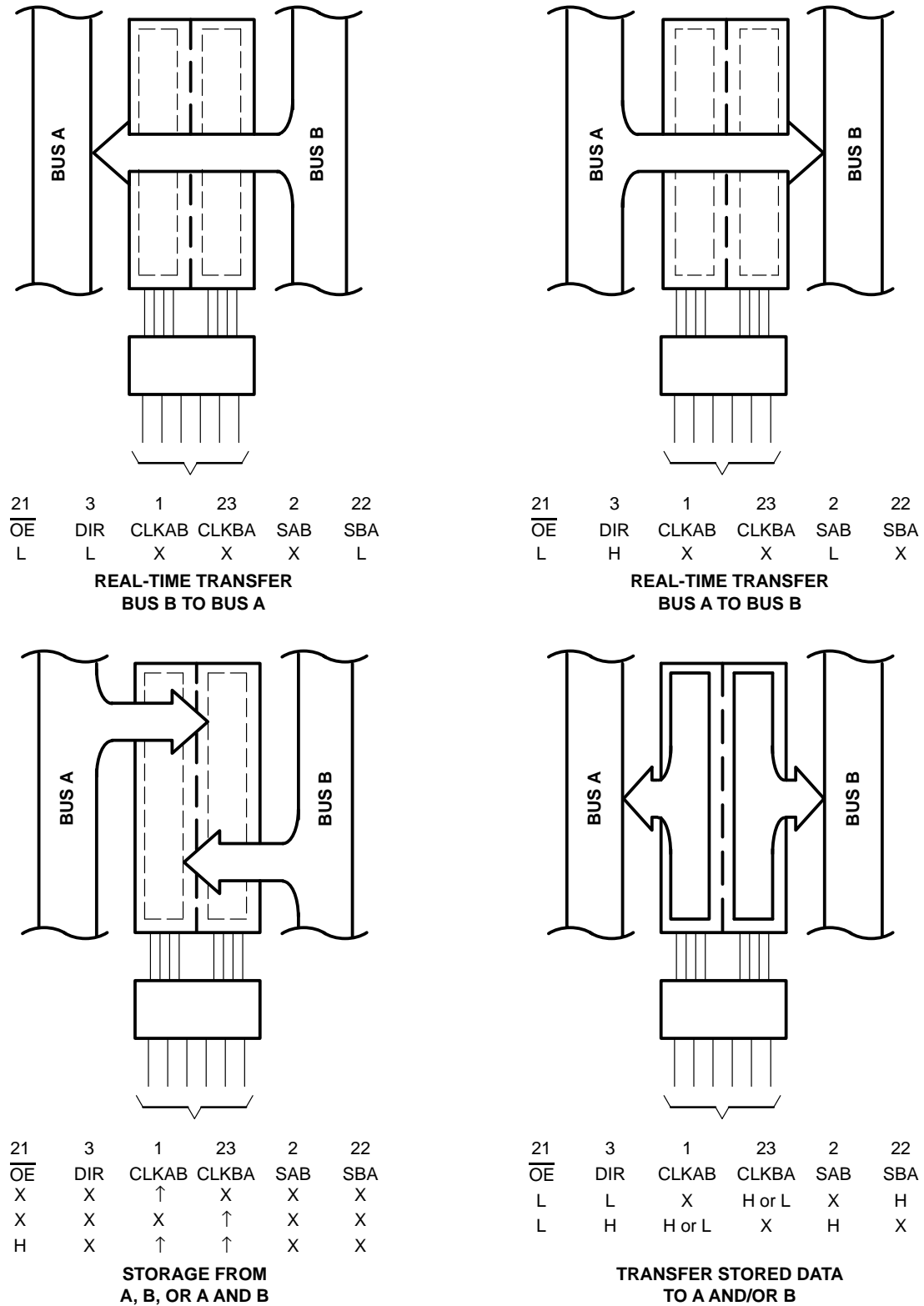
FUNCTION TABLE

INPUTS						DATA I/O		OPERATION OR FUNCTION
\overline{OE}	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
X	X	↑	X	X	X	Input	Unspecified†	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified†	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B bus
L	H	H or L	X	H	X	Input	Output	Stored A data to B bus

† The data-output functions can be enabled or disabled by various signals at \overline{OE} and DIR. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

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Pin numbers shown are for the DW, JT, NT, and W packages.

Figure 1. Bus-Management Functions

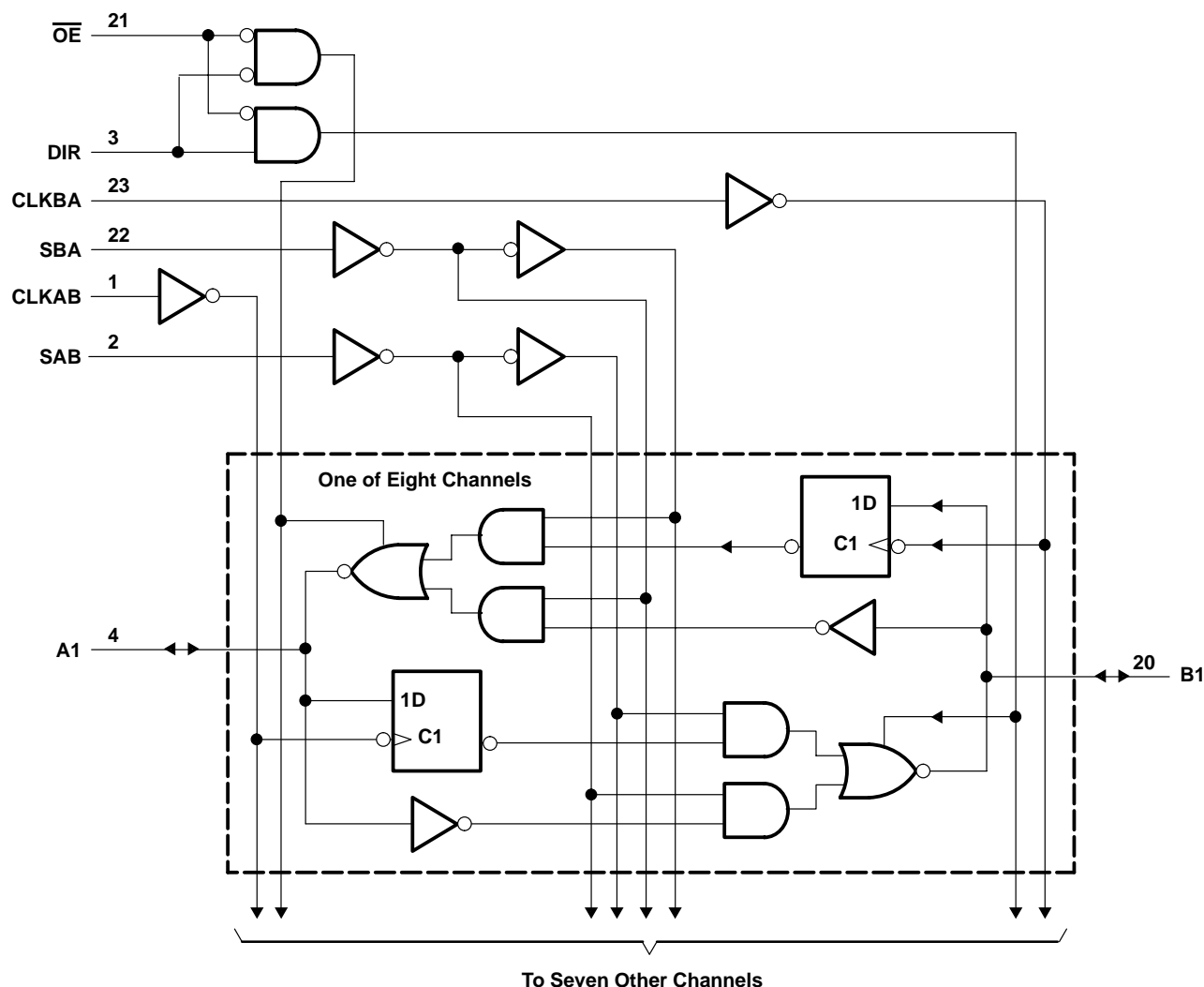
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OCTAL BUS TRANSCEIVERS AND REGISTERS

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logic diagram (positive logic)



Pin numbers shown are for the DW, JT, NT, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±35 mA
Continuous current through V_{CC} or GND	±70 mA
Package thermal impedance, θ_{JA} (see Note 2): DW package	46°C/W
(see Note 3): NT package	67°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The package thermal impedance is calculated in accordance with JESD 51-7.
 3. The package thermal impedance is calculated in accordance with JESD 51-3.



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OCTAL BUS TRANSCEIVERS AND REGISTERS

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recommended operating conditions (see Note 4)

		SN54HCT646			SN74HCT646			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 4.5 V to 5.5 V			2			V
V _{IL}	Low-level input voltage	V _{CC} = 4.5 V to 5.5 V			0.8			V
V _I	Input voltage	0		V _{CC}	0		V _{CC}	V
V _O	Output voltage	0		V _{CC}	0		V _{CC}	V
t _t	Input transition (rise and fall) time			500			500	ns
T _A	Operating free-air temperature	–55		125	–40		85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V _{CC}	T _A = 25°C			SN54HCT646		SN74HCT646		UNIT
					MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}		V _I = V _{IH} or V _{IL}	I _{OH} = –20 µA	4.5 V	4.4	4.499		4.4		4.4		V
			I _{OH} = –6 mA		3.98	4.3		3.7		3.84		
V _{OL}		V _I = V _{IH} or V _{IL}	I _{OL} = 20 µA	4.5 V		0.001	0.1		0.1		0.1	V
			I _{OL} = 6 mA			0.17	0.26		0.4		0.33	
I _I	Control inputs	V _I = V _{CC} or 0		5.5 V	±0.1	±100		±1000		±1000		nA
I _{OZ}	A or B	V _O = V _{CC} or 0		5.5 V	±0.01	±0.5		±10		±5		µA
I _{CC}		V _I = V _{CC} or 0, I _O = 0		5.5 V			8	160		80		µA
ΔI _{CC} †		One input at 0.5 V or 2.4 V, Other inputs at 0 or V _{CC}		5.5 V		1.4	2.4	3		2.9		mA
C _i	Control inputs			4.5 V to 5.5 V		3	10	10		10		pF

† This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V _{CC}	T _A = 25°C		SN54HCT646		SN74HCT646		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	4.5 V		31		22		27	MHz
		5.5 V		36		24		29	
t _w	Pulse duration, CLKBA or CLKAB high or low	4.5 V		16		23		19	ns
		5.5 V		14		21		17	
t _{su}	Setup time, A before CLKAB↑ or B before CLKBA↑	4.5 V		20		30		25	ns
		5.5 V		18		27		23	
t _h	Hold time, A after CLKAB↑ or B after CLKBA↑	4.5 V		5		5		5	ns
		5.5 V		5		5		5	

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OCTAL BUS TRANSCEIVERS AND REGISTERS

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switching characteristics over recommended operating free-air temperature range, $C_L = 50$ pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	$T_A = 25^\circ\text{C}$			SN54HCT646		SN74HCT646		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{\max}			4.5 V	31	54		22		27		MHz
			5.5 V	36	64		24		29		
t_{pd}	CLKBA or CLKAB	A or B	4.5 V		18	36		54		45	ns
			5.5 V		16	32		49		41	
	A or B	B or A	4.5 V		14	27		41		34	
			5.5 V		12	24		37		31	
	SBA or SAB†	A or B	4.5 V		20	38		57		48	
			5.5 V		17	34		51		43	
t_{en}	\overline{OE}	A or B	4.5 V		25	49		74		61	ns
			5.5 V		22	44		67		55	
t_{dis}	\overline{OE}	A or B	4.5 V		25	49		74		61	ns
			5.5 V		22	44		67		55	
t_{en}	DIR	A or B	4.5 V		25	49		74		61	ns
			5.5 V		22	44		67		55	
t_{dis}	DIR	A or B	4.5 V		25	49		74		61	ns
			5.5 V		22	44		67		55	
t_t		Any	4.5 V		9	12		18		15	ns
			5.5 V		7	11		16		14	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

switching characteristics over recommended operating free-air temperature range, $C_L = 150$ pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	$T_A = 25^\circ\text{C}$			SN54HCT646		SN74HCT646		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	CLKBA or CLKAB	A or B	4.5 V		24	53		80		66	ns
			5.5 V		22	47		52		60	
	A or B	B or A	4.5 V		22	44		67		55	
			5.5 V		20	39		60		50	
	SBA or SAB†	A or B	4.5 V		26	55		83		69	
			5.5 V		24	49		74		62	
t_{en}	\overline{OE}	A or B	4.5 V		33	66		100		87	ns
			5.5 V		22	59		90		74	
	DIR	A or B	4.5 V		33	66		100		87	
			5.5 V		22	59		90		74	
t_t		Any	4.5 V		17	42		63		53	ns
			5.5 V		14	38		57		48	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	No load	50	pF

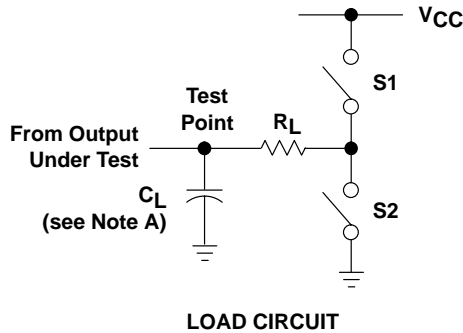
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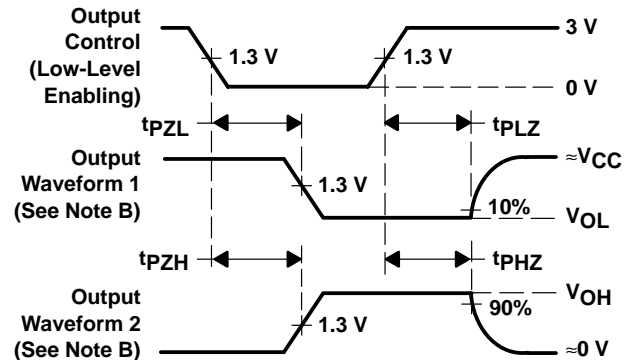
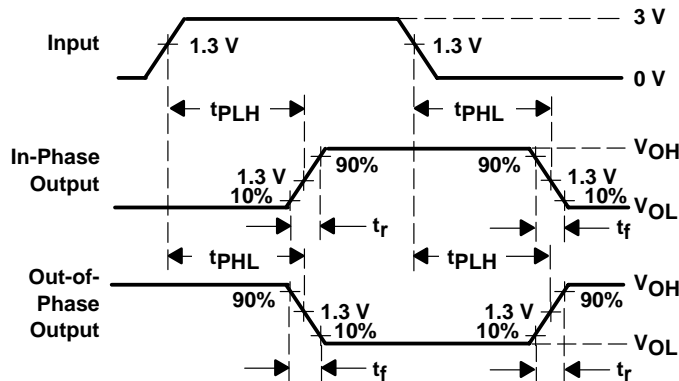
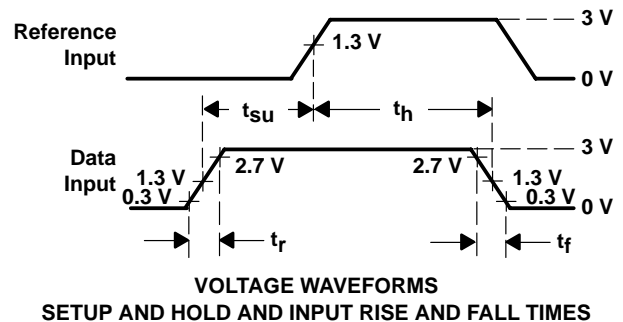
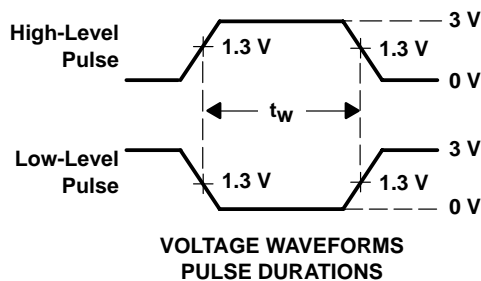
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PARAMETER MEASUREMENT INFORMATION



PARAMETER	R_L	C_L	S1	S2
t_{en}	1 k Ω	50 pF or 150 pF	Open	Closed
			Closed	Open
t_{dis}	1 k Ω	50 pF	Open	Closed
			Closed	Open
t_{pd} or t_t	—	50 pF or 150 pF	Open	Open



- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_O = 50 \Omega$, $t_r = 6$ ns, $t_f = 6$ ns.
 - D. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
 - E. The outputs are measured one at a time with one input transition per measurement.
 - F. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - G. t_{PZL} and t_{PZH} are the same as t_{en} .
 - H. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74HCT646DW	Active	Production	SOIC (DW) 24	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HCT646
SN74HCT646DW.A	Active	Production	SOIC (DW) 24	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HCT646

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74HCT646DW	DW	SOIC	24	25	506.98	12.7	4826	6.6
SN74HCT646DW.A	DW	SOIC	24	25	506.98	12.7	4826	6.6

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-013 variation AD.

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